

MOSFETs Silicon N-channel MOS (U-MOSVII-H)

# TK65E10N1

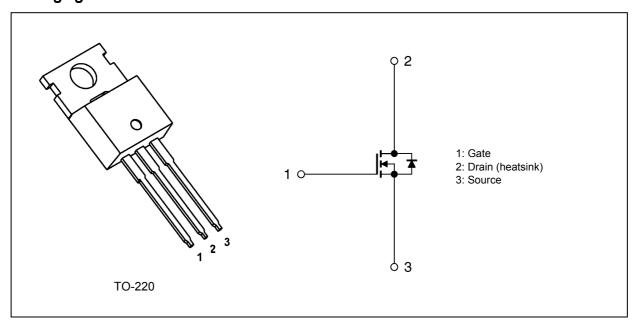
#### 1. Applications

• Switching Voltage Regulators

#### 2. Features

- (1) Low drain-source on-resistance:  $R_{DS(ON)} = 4.0 \text{ m}\Omega$  (typ.) ( $V_{GS} = 10 \text{ V}$ )
- (2) Low leakage current:  $I_{DSS} = 10 \mu A \text{ (max) (V}_{DS} = 100 \text{ V)}$
- (3) Enhancement mode:  $V_{th}$  = 2.0 to 4.0 V ( $V_{DS}$  = 10 V,  $I_{D}$  = 1.0 mA)

### 3. Packaging and Internal Circuit



# 4. Absolute Maximum Ratings (Note) (Ta = 25°C unless otherwise specified)

Characteris	Symbol	Rating	Unit		
Drain-source voltage			$V_{DSS}$	100	V
Gate-source voltage			$V_{GSS}$	±20	
Drain current (DC)	(Silicon limit)	(Note 1,2)	I <sub>D</sub>	148	Α
Drain current (DC)		(Note 1,3)	I <sub>D</sub>	65	1
Drain current (pulsed)	(t = 1 ms)	(Note 1)	I <sub>DP</sub>	296	1
Power dissipation	(T <sub>c</sub> = 25°C)		$P_{D}$	192	W
Single-pulse avalanche energy		(Note 4)	E <sub>AS</sub>	143	mJ
Avalanche current			I <sub>AR</sub>	65	Α
Channel temperature			T <sub>ch</sub>	150	°C
Storage temperature			T <sub>stg</sub>	-55 to 150	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Start of commercial production



#### 5. Thermal Characteristics

Characteristics	Symbol	Max	Unit
Channel-to-case thermal resistance	R <sub>th(ch-c)</sub>	0.65	°C/W
Channel-to-ambient thermal resistance	R <sub>th(ch-a)</sub>	83.3	

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: Limited by silicon chip capability. Package limit is 100 A.

Note 3: Device mounted with heatsink so that  $R_{th(ch-a)}$  becomes 2.77°C/W.

Note 4:  $V_{DD}$  = 80 V,  $T_{ch}$  = 25°C (initial), L = 26.1  $\mu H,\ I_{AR}$  = 65 A

Note: This transistor is sensitive to electrostatic discharge and should be handled with care.



#### 6. Electrical Characteristics

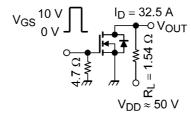
## 6.1. Static Characteristics (T<sub>a</sub> = 25°C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current	I <sub>GSS</sub>	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±0.1	μΑ
Drain cut-off current	I <sub>DSS</sub>	V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V	_	-	10	
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	I <sub>D</sub> = 10 mA, V <sub>GS</sub> = 0 V	100	_	_	V
Drain-source breakdown voltage (Note 5)	V <sub>(BR)DSX</sub>	I <sub>D</sub> = 10 mA, V <sub>GS</sub> = -20 V	65	_	_	
Gate threshold voltage	V <sub>th</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1.0 mA	2.0	_	4.0	
Drain-source on-resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 32.5 A	_	4.0	4.8	mΩ

Note 5: If a reverse bias is applied between gate and source, this device enters  $V_{(BR)DSX}$  mode. Note that the drain-source breakdown voltage is lowered in this mode.

## 6.2. Dynamic Characteristics (T<sub>a</sub> = 25°C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Input capacitance	C <sub>iss</sub>	V <sub>DS</sub> = 50 V, V <sub>GS</sub> = 0 V, f = 1 MHz	_	5400	_	pF
Reverse transfer capacitance	C <sub>rss</sub>		_	42	_	
Output capacitance	C <sub>oss</sub>		_	950	_	
Gate resistance	r <sub>g</sub>	_	_	2.4	_	Ω
Switching time (rise time)	t <sub>r</sub>	See Figure 6.2.1	_	19	_	ns
Switching time (turn-on time)	t <sub>on</sub>		_	44	_	
Switching time (fall time)	t <sub>f</sub>		_	26	_	
Switching time (turn-off time)	t <sub>off</sub>		_	85	_	



Duty  $\leq$  1%,  $t_{\text{W}} =$  10  $\mu \text{s}$ 

Fig. 6.2.1 Switching Time Test Circuit

## 6.3. Gate Charge Characteristics (T<sub>a</sub> = 25°C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Total gate charge (gate-source plus gate-drain)	$Q_g$	$V_{DD} \approx 80 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 65 \text{ A}$	ı	81	1	nC
Gate-source charge 1	Q <sub>gs1</sub>		_	31		
Gate-drain charge	$Q_{gd}$		_	18	_	
Gate switch charge	$Q_{SW}$		_	32	_	



## 6.4. Source-Drain Characteristics (T<sub>a</sub> = 25°C unless otherwise specified)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Reverse drain current (DC)	(Note 6)	I <sub>DR</sub>	_	_	_	65	Α
Reverse drain current (pulsed)	(Note 6)	I <sub>DRP</sub>	_	_	_	296	
Diode forward voltage		$V_{DSF}$	I <sub>DR</sub> = 65 A, V <sub>GS</sub> = 0 V	_	_	-1.2	V
Reverse recovery time	(Note 7)	t <sub>rr</sub>	I <sub>DR</sub> = 65 A, V <sub>GS</sub> = 0 V	_	76	_	ns
Reverse recovery charge	(Note 7)	Q <sub>rr</sub>	-dI <sub>DR</sub> /dt = 100 A/μs	_	150	_	nC

Note 6: Ensure that the channel temperature does not exceed 150°C.

Note 7: Ensure that  $V_{DS}$  peak does not exceed  $V_{DSS}$ .

### 7. Marking

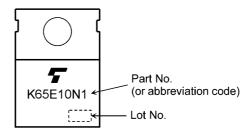


Fig. 7.1 Marking

#### 8. Characteristics Curves (Note)

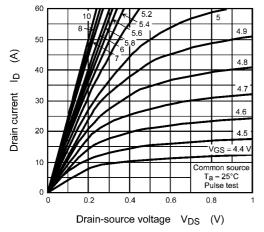


Fig. 8.1 I<sub>D</sub> - V<sub>DS</sub>

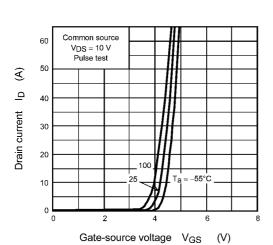


Fig. 8.3  $I_D - V_{GS}$ 

Puise test

Poston

Po

100

Common source

T<sub>a</sub> = 25°C Pulse test

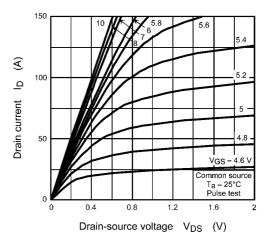
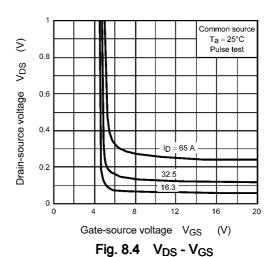


Fig. 8.2 I<sub>D</sub> - V<sub>DS</sub>



**0** 50 00

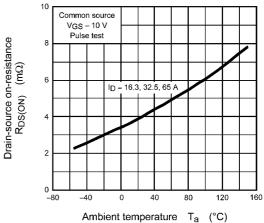


Fig. 8.6 R<sub>DS(ON)</sub> - T<sub>a</sub>

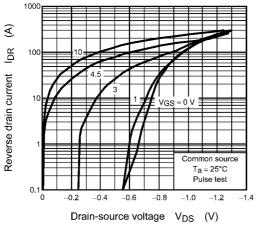


Fig. 8.7 IDR - VDS

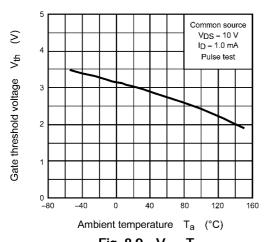


Fig. 8.9 V<sub>th</sub> - T<sub>a</sub>

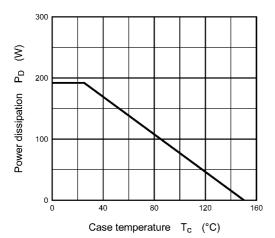


Fig. 8.11 P<sub>D</sub> - T<sub>c</sub> (Guaranteed Maximum)

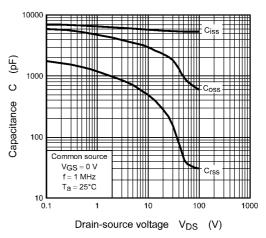


Fig. 8.8 Capacitance - V<sub>DS</sub>

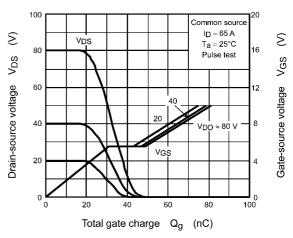


Fig. 8.10 Dynamic Input/Output Characteristics

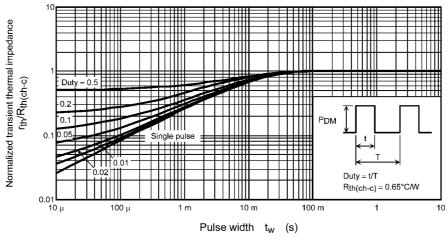


Fig. 8.12  $r_{th}/R_{th(ch-c)} - t_w$  (Guaranteed Maximum)

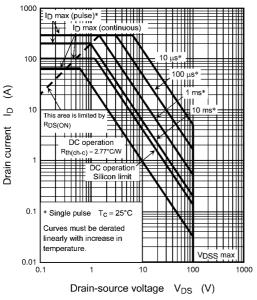


Fig. 8.13 Safe Operating Area (Guaranteed Maximum)

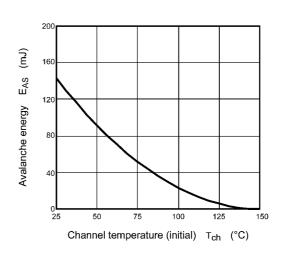


Fig. 8.14 E<sub>AS</sub> - T<sub>ch</sub> (Guaranteed Maximum)

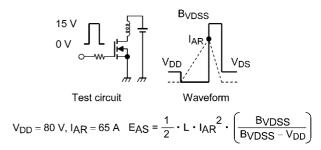


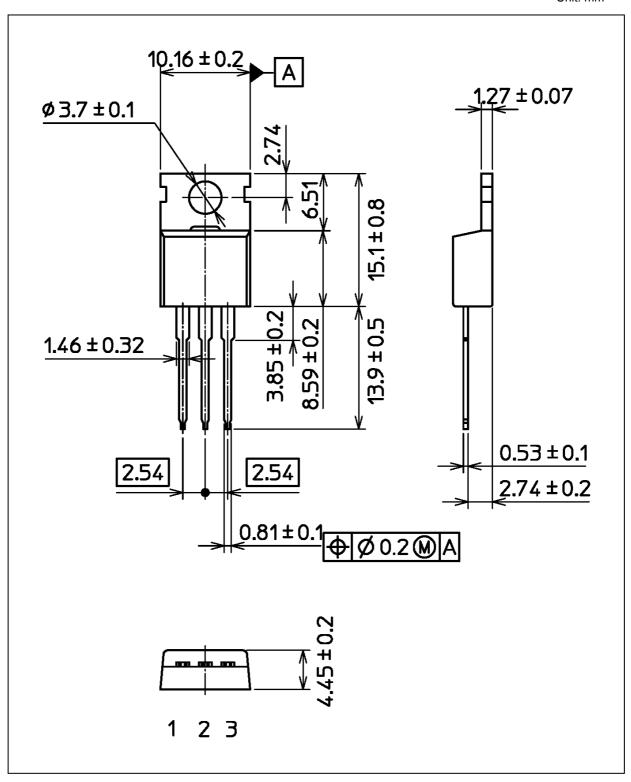
Fig. 8.15 Test Circuit/Waveform

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



## **Package Dimensions**

Unit: mm



Weight: 1.93 g (typ.)

	Package Name(s)
TOSHIBA: 2-10X1A	
Nickname: TO-220	



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